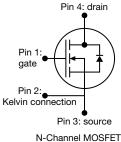
Vishay Siliconix



E Series Power MOSFET





PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.155				
Q _g max. (nC)	33				
Q _{gs} (nC)	7				
Q _{gd} (nC)	11				
Configuration	Single				

FEATURES

- 4th generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- · Kelvin connection for reduced gate noise
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8
Lead (Pb)-free and halogen-free	SiHH180N60E-T1-GE3

ABSOLUTE MAXIMUM RATINGS	$(T_C = 25 \ ^{\circ}C, \text{ unless other})$	wise noted)		
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	600	v
Gate-source voltage		V _{GS}	± 30	v
Continuous drain surrant (T $= 150$ °C)	V_{GS} at 10 V $\frac{T_{C} = 25^{\circ}}{T_{C} = 100^{\circ}}$		19	
Continuous drain current ($T_J = 150 \ ^\circ C$)	V_{GS} at 10 V $T_C = 100^{\circ}$	C I _D	12	А
Pulsed drain current ^a	I _{DM}	44		
Linear derating factor			0.9	W/°C
Single pulse avalanche energy ^b		E _{AS}	111	mJ
Maximum power dissipation	PD	114	W	
Operating junction and storage temperature ra	ange	T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope	C dv/dt	100	V/ns	
Reverse diode dv/dt ^c	uv/ui	22	V/115	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

- b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 2.8 A
- c. $I_{SD} \leq I_D$, di/dt = 100 A/µs, starting T_J = 25 °C

RoHS COMPLIANT

HALOGEN

FREE



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THERMAL RESISTANCE RA	TINGS						
PARAMETER	SYMBOL	TYP.	MAX.			UNIT	
Maximum junction-to-ambient	R _{thJA}	42	55	80.00			
Maximum junction-to-case (drain)	R _{thJC}	0.76	1.1		°C/W		
SPECIFICATIONS $(T_J = 25 \ ^{\circ}C_s)$	unless otherwi	ise noted)					
PARAMETER	SYMBOL	TEST CONDITIONS MIN		MIN.	TYP.	MAX.	UNIT
Static							
D :		N/ 0.1/1 050	•	000			14

Static							
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I _D = 1 mA		-	0.63	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		3.0	-	5.0	V
	1	$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Gate-source leakage	I _{GSS}		V _{GS} = ± 30 V	-	-	± 1	μA
7		V _{DS} =	= 600 V, V _{GS} = 0 V	-	-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V	/, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 9.5 A	-	0.155	0.180	Ω
Forward transconductance ^a	9 _{fs}	V _{DS} :	= 20 V, I _D = 9.5 A	-	5.3	-	S
Dynamic		•			•		
Input capacitance	C _{iss}		V _{GS} = 0 V,	-	1085	-	
Output capacitance	C _{oss}	1	$V_{DS} = 100 V,$	-	56	-	1
Reverse transfer capacitance	C _{rss}	1	f = 1 MHz	-	5	-	1
Effective output capacitance, energy related ^a	C _{o(er)}	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		-	41	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}			-	251	-	1
Total gate charge	Qg	† 1 †		-	22	33	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	V _{GS} = 10 V I _D = 9.5 A, V _{DS} = 480 V		7	-	nC
Gate-drain charge	Q _{qd}			-	11	-	1
Turn-on delay time	t _{d(on)}			-	14	28	
Rise time	t _r	V _{DD} = 480 V, I _D = 9.5 A,		-	49	98	- ns
Turn-off delay time	t _{d(off)}		$V_{\rm GS} = 10 \text{ V}, \text{ R}_{\rm g} = 9.1 \Omega$		22	44	
Fall time	t _f			-	23	46	1
Gate input resistance	R _g	f = 1 MHz		0.3	0.7	1.4	Ω
Drain-Source Body Diode Characteristic	cs				•		
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	19	
Pulsed diode forward current	I _{SM}			-	-	44	A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 9.5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 9.5 \text{ A},$ di/dt = 100 A/ μ s, V _R = 25 V		-	282	564	ns
Reverse recovery charge	Q _{rr}			-	3.6	7.2	μC
Reverse recovery current	I _{BRM}			-	24	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

2



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

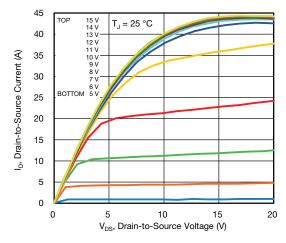


Fig. 1 - Typical Output Characteristics

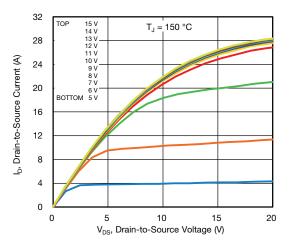


Fig. 2 - Typical Output Characteristics

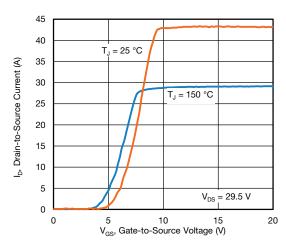


Fig. 3 - Typical Transfer Characteristics

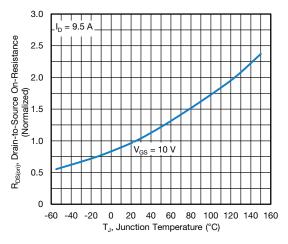


Fig. 4 - Normalized On-Resistance vs. Temperature

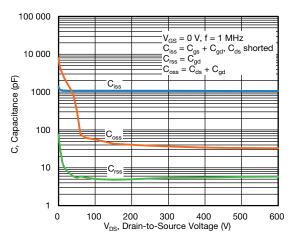


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

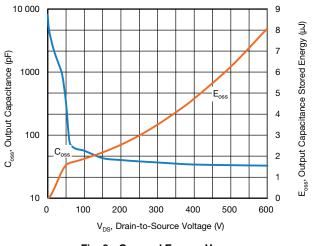


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

S20-0339-Rev. C, 11-May-2020

3

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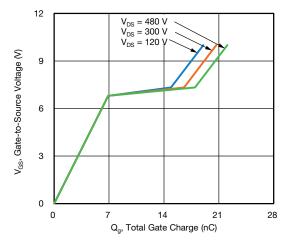


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

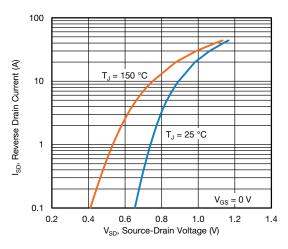


Fig. 8 - Typical Source-Drain Diode Forward Voltage

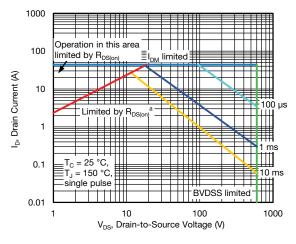


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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4

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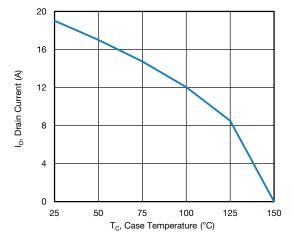


Fig. 10 - Maximum Drain Current vs. Case Temperature

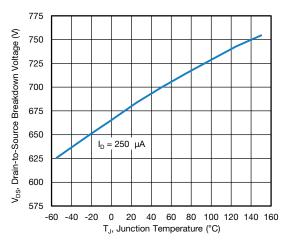
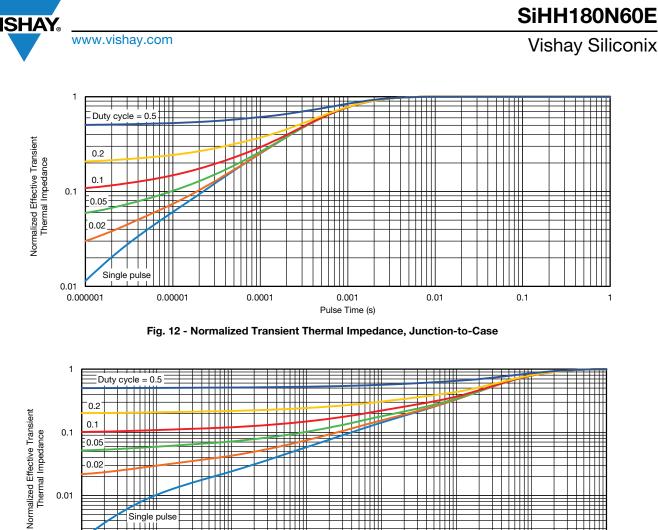


Fig. 11 - Temperature vs. Drain-to-Source Voltage



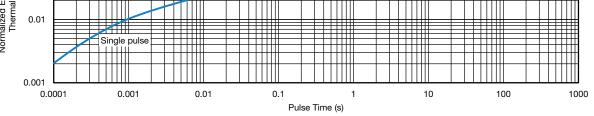


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

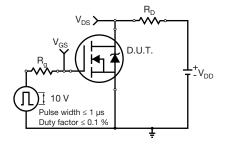


Fig. 14 - Switching Time Test Circuit

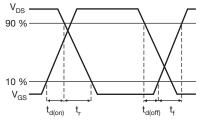


Fig. 15 - Switching Time Waveforms



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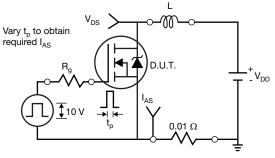


Fig. 16 - Unclamped Inductive Test Circuit

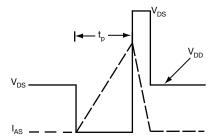


Fig. 17 - Unclamped Inductive Waveforms

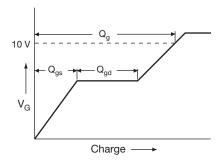


Fig. 18 - Basic Gate Charge Waveform

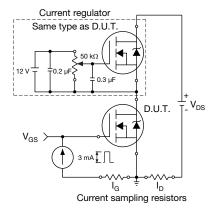
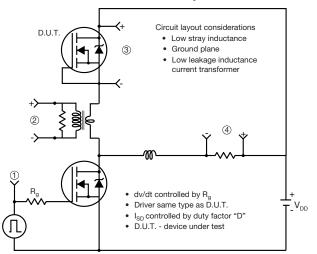


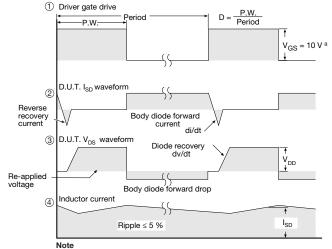
Fig. 19 - Gate Charge Test Circuit

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Peak Diode Recovery dv/dt Test Circuit





a. $V_{GS} = 5$ V for logic level devices

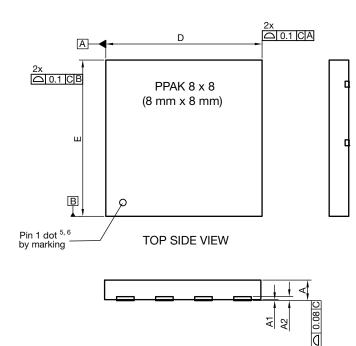
Fig. 20 - For N-Channel

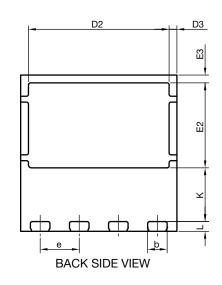
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PowerPAK[®] 8 x 8 Case Outline





DIM.	MILLIMETERS			INCHES			
DIN.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
А	0.95	1.00	1.05	0.037	0.039	0.041	
A1	0.00	-	0.05	0.000	-	0.002	
A2		020 ref.		0.008 ref.			
b	0.95	1.00	1.05	0.037	0.039	0.041	
D	7.90	8.00	8.10	0.311	0.315	0.319	
D2	7.10	7.20	7.30	0.280	0.283	0.287	
D3		0.40 BSC			0.016 BSC		
е		2.00 BSC 0.079 BSC					
E	7.90	8.00	8.10	0.311	0.315	0.319	
E2	4.30	4.35	4.40	0.169	0.171	0.173	
E3	0.40 BSC				0.016 BSC		
К	2.75 BSC			0.108 BSC			
L	0.45	0.50	0.55	0.018	0.020	0.022	
N ⁽³⁾		8		8			

Notes

 $^{\left(1\right) }$ Use millimeters as the primary measurement

⁽²⁾ Dimensioning and tolerances conform to ASME Y14.5 M - 1994

⁽³⁾ N is the number of terminals

⁽⁴⁾ The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body

⁽⁵⁾ Exact shape and size of this feature is optional

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Revision: 28-Sep-2020

1



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Recommended Minimum PADs for PowerPAK[®] 8 mm x 8 mm



Dimensions in millimeters

Document Number: 68441



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